

Features

- Guard Ring Die Construction for Transient Protection
- High Current Capability
- Low Leakage Current
- Patented Interlocking Clip Design for High Surge Current Capacity
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
<https://www.diodes.com/quality/product-definitions/>
- An Automotive-Compliant Part is Available Under Separate Datasheet ([DFLS240Q](#))

Mechanical Data

- Package: PowerDI[®]123
- Package Material: Molded Plastic, "Green" Molding Compound
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish – Matte Tin Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.01 grams (Approximate)

PowerDI123



Top View

Ordering Information (Note 4)

Part Number	Package	Packing	
		Qty.	Carrier
DFLS240-7	PowerDI123	3000	Tape & Reel

Notes:

- EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



F04A = Product Type Marking Code

YM = Date Code Marking

Y = Year (ex: J = 2022)

M = Month (ex: 9 = September)

Date Code Key

Year	2006	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	T	J	K	L	M	N	O	P	R	S	T
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	V_{RWM}	40	V
DC Blocking Voltage	V_R		
RMS Reverse Voltage	$V_R(\text{RMS})$	28	V
Average Forward Current	$I_F(\text{AV})$	2.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	40	A

Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{\theta JA}$	73	—	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Soldering Point (Note 6)	$R_{\theta JS}$	—	13	$^\circ\text{C}/\text{W}$
Operating Temperature Range	T_J	-65 to +125		$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-65 to +150		$^\circ\text{C}$

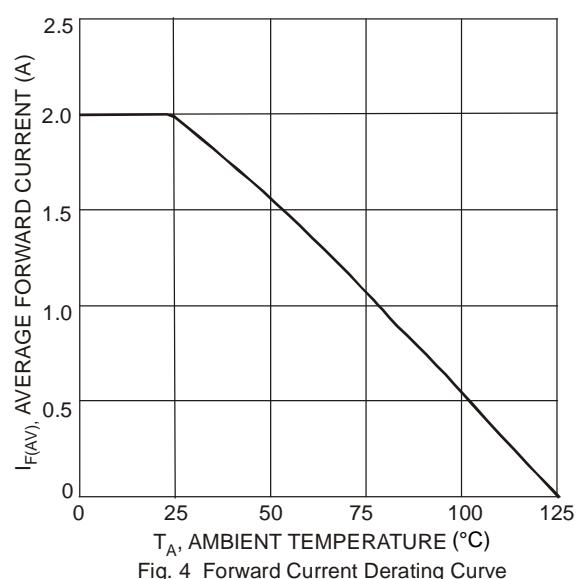
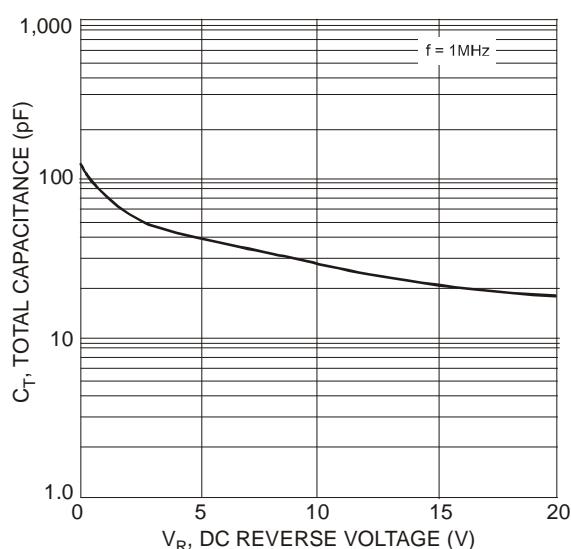
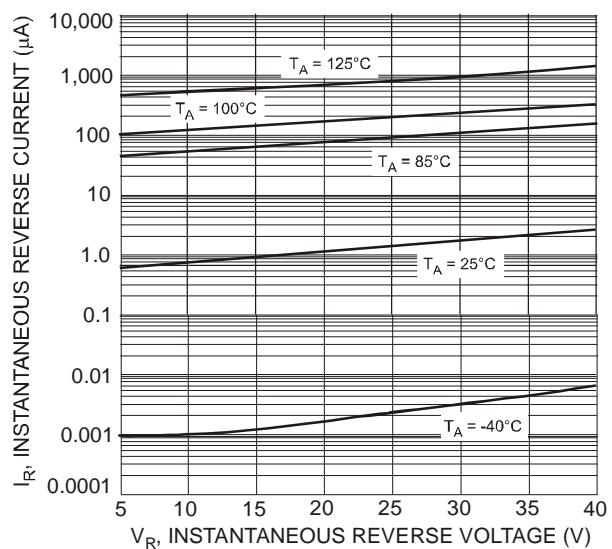
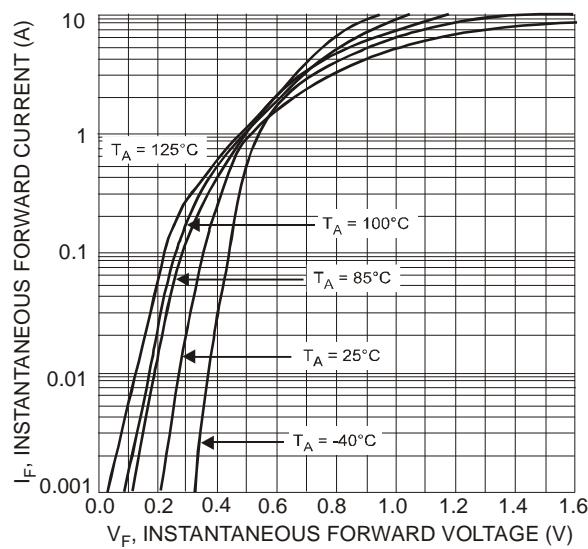
Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	40	—	—	V	$I_R = 20\mu\text{A}$
Forward Voltage	V_F	— —	0.52 0.65	0.58 0.7	V	$I_F = 1.0\text{A}$ $I_F = 2.0\text{A}$
Leakage Current (Note 7)	I_R	— —	— —	20 6.0	μA mA	$V_R = 40\text{V}, T_A = +25^\circ\text{C}$ $V_R = 40\text{V}, T_A = +100^\circ\text{C}$
Total Capacitance	C_T	—	28	—	pF	$V_R = 10\text{V}, f = 1.0\text{MHz}$

Notes: 5. Part mounted on Polymide board with 2oz copper, 74mm² pad layout. $T_A = +25^\circ\text{C}$.

6. Theoretical $R_{\theta JS}$ calculated from the top center of the die straight down to the PCB/cathode tab solder junction.

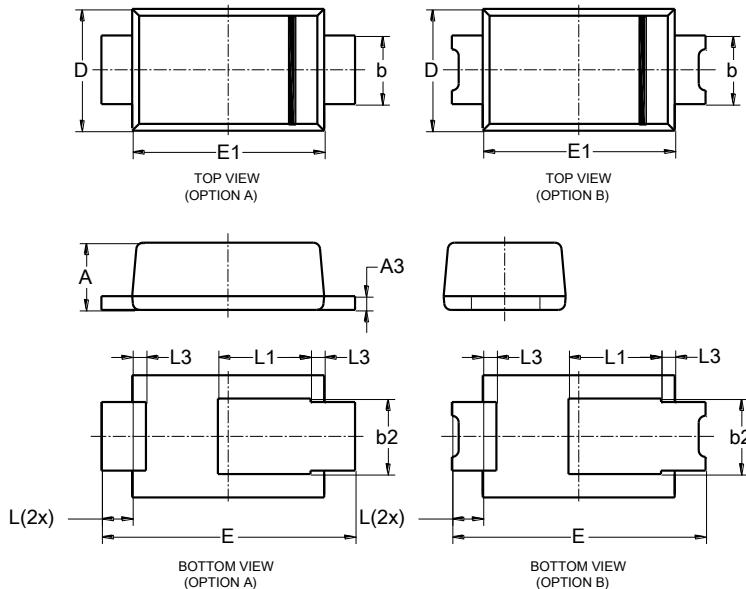
7. Short duration pulse test used to minimize self-heating effect.



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI123



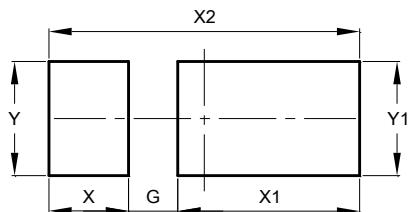
PowerDI123			
Dim	Min	Max	Typ
A	0.93	1.00	0.98
A3	0.15	0.25	0.20
b	0.85	1.25	1.00
b2	1.025	1.125	1.10
D	1.63	1.93	1.78
E	3.50	3.90	3.70
E1	2.60	3.00	2.80
L	0.40	0.50	0.45
L1	1.25	1.40	1.35
L3	0.125	0.275	0.20

All Dimensions in mm

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI123



Dimensions	Value (in mm)
G	0.65
X	1.05
X1	2.40
X2	4.10
Y	1.50
Y1	1.50

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